MOSFET – Power, Single, N-Channel, SO-8 FL

30 V, 210 A

Features

- Low R_{DS(on)} to Improve Conduction and Overall Efficiency
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- OR-ing FET, Power Load Switch, Motor Control
- Refer to Application Note AND8195/D for Mounting Information **End Products**
- Server, UPS, Fault-Tolerant Power Systems, Hot Swap

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Para	meter		Symbol	Value	Unit
Drain-to-Source Volta	ge		V_{DSS}	30	V
Gate-to-Source Voltaç	ge		V_{GS}	±20	V
Continuous Drain		T _A = 25°C	I _D	34	Α
Current R _{θJA} (Note 1)		T _A = 100°C		21.5	
Power Dissipation $R_{\theta JA}$ (Note 1)		T _A = 25°C	P _D	2.74	W
Continuous Drain		T _A = 25°C	I _D	43	Α
Current R _{θJA} ≤ 10 s (Note 1)	•	T _A = 100°C		27	1
$\begin{array}{l} \text{Power Dissipation} \\ R_{\theta JA} \leq \text{10 s (Note 1)} \end{array}$	Steady	T _A = 25°C	P _D	7.3	W
Continuous Drain	State	T _A = 25°C	I _D	20	Α
Current R _{θJA} (Note 2)		T _A = 100°C		12.5	
Power Dissipation $R_{\theta JA}$ (Note 2)		T _A = 25°C	P _D	1.06	W
Continuous Drain		T _C = 25°C	I _D	210	Α
Current R _{θJC} (Note 1)		T _C =100°C		132	1
Power Dissipation R ₀ JC (Note 1)		T _C = 25°C	P _D	104	W
Pulsed Drain Current	$T_A = 25^{\circ}$	C, t _p = 10 μs	I _{DM}	400	Α
Operating Junction and	d Storage	Temperature	T _J , T _{STG}	-55 to +150	°C
Source Current (Body	Diode)		I _S	95	Α
Drain to Source DV/DT	-		dV/d _t	4.4	V/ns
Single Pulse Drain-to- Energy ($T_J = 25$ °C, V_D $I_L = 58 A_{pk}$, $L = 0.3 mH$	_D = 24 V, \	$I_{GS} = 10 \text{ V},$	E _{AS}	504	mJ
Lead Temperature for \$\((1/8''\) from case for 10		Purposes	T _L	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

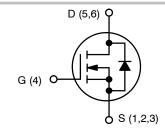
1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.



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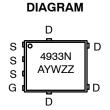
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	1.2 mΩ @ 10 V	210 A
30 V	2.0 mΩ @ 4.5 V	210 A



N-CHANNEL MOSFET



SO-8 FLAT LEAD CASE 488AA STYLE 1



MARKING

A = Assembly Location Y = Year

W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4933NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4933NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

2.	Surface-mounted on FR4 board using the minimum recommended pad size. (Cu area = 50 mm² [1 oz])

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ heta JC}$	1.1	
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	45.6	°C/W
Junction-to-Ambient - Steady State (Note 4)	$R_{\theta JA}$	117.5	- C/VV
Junction-to-Ambient - (t ≤ 10 s) (Note 3)	$R_{\theta JA}$	17.13	

- Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
 Surface-mounted on FR4 board using the minimum recommended pad size. (Cu area = 50 mm² [1 oz])

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				15		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			1.0	
		V _{DS} = 24 V	T _J = 125°C			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	s = ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μΑ	1.2	1.6	2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		0.9	1.2	
			I _D = 15 A		0.9		0
		V _{GS} = 4.5 V	I _D = 30 A		1.5	2.0	mΩ
			I _D = 15 A		1.5		
Forward Transconductance	g _{FS}	V _{DS} = 1.5 V, I _D = 15 A			82		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 15 V			10930		pF
Output Capacitance	C _{OSS}				3230		
Reverse Transfer Capacitance	C _{RSS}				92		1
Total Gate Charge	Q _{G(TOT)}				62.1		200
Threshold Gate Charge	Q _{G(TH)}	V 45VV	45 \/. L 20 A		15.7		
Gate-to-Source Charge	Q_{GS}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 15 \text{ V}; I_D = 30 \text{ A}$			27		nC
Gate-to-Drain Charge	Q_{GD}				10.1		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15 V; I _D = 30 A			148		nC
SWITCHING CHARACTERISTICS (Note 6)							
Turn-On Delay Time	t _{d(ON)}				31		
Rise Time	t _r	V_{GS} = 4.5 V, V_{DS} = 15 V, I_{D} = 15 A, R_{G} = 3.0 Ω			33		ns
Turn-Off Delay Time	t _{d(OFF)}				47		
Fall Time	t _f				23		

- 5. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.
 6. Switching characteristics are independent of operating junction temperatures.

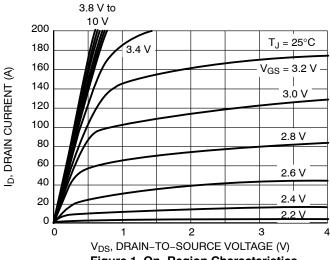
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Cond	dition	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (N					-71		
Turn-On Delay Time	t _{d(ON)}				20		
Rise Time	t _r	V_{GS} = 10 V, V_{DS} = 15 V, I_{D} = 15 A, R_{G} = 3.0 Ω			26		1
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 15 A, R_G$	$_{i}$ = 3.0 Ω		88.6		ns
Fall Time	t _f	1			22		1
DRAIN-SOURCE DIODE CHARACTI	ERISTICS						
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V,	$V_{CS} = 0 \text{ V}$ $T_J = 25^{\circ}\text{C}$		0.82	1.1	V
		I _S = 30 A	T _J = 125°C		0.68		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, dIS/dt} = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 30 \text{ A}$			73.5		ns
Charge Time	t _a				35.9		
Discharge Time	t _b				37.6		
Reverse Recovery Charge	Q _{RR}				117		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S				0.50		nH
Drain Inductance	L _D	T _A = 25°C			0.005		nH
Gate Inductance	L _G				1.84		nH
Gate Resistance	R_{G}				1.1	2.2	Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{5.} Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



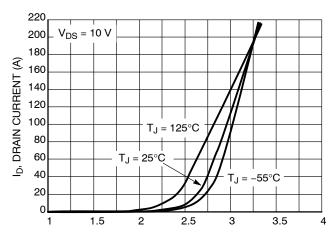
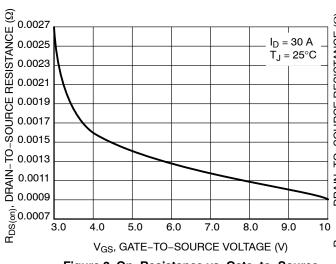


Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



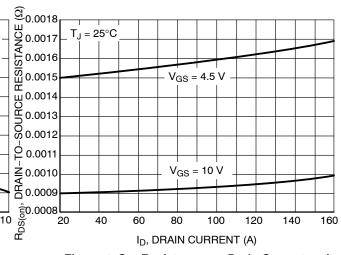


Figure 3. On-Resistance vs. Gate-to-Source Voltage

Figure 4. On-Resistance vs. Drain Current and Gate Voltage

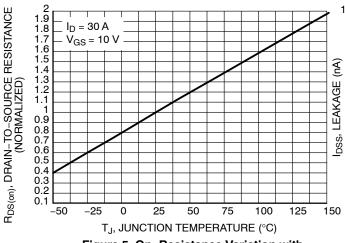


Figure 5. On–Resistance Variation with Temperature

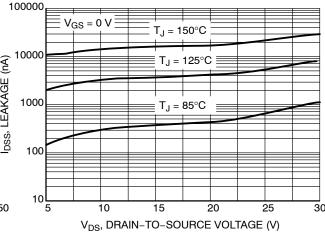
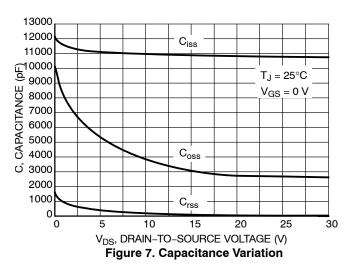


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



10 V_{GS}, GATE-TO-SOURCE VOLTAGE (V) $T_J = 25^{\circ}C$ 8 7 Q_T 6 5 4 Q_{GS} 3 Q_{GD} V_{DD} = 15 V 2 V_{GS} = 10 V I_D = 30 A 60 80 100 120 140 Q_G, TOTAL GATE CHARGE (nC)

Figure 8. Gate-To-Source and Drain-To-Source Voltage vs. Total Charge

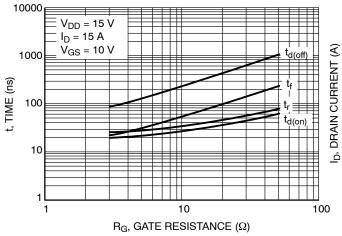


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

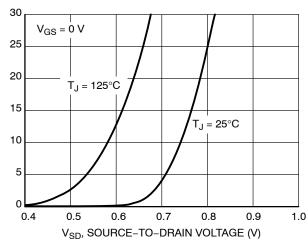


Figure 10. Diode Forward Voltage vs. Current

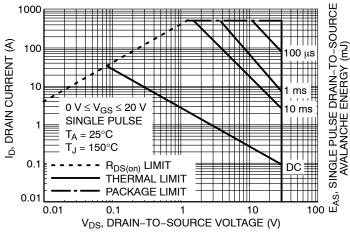


Figure 11. Maximum Rated Forward Biased Safe Operating Area

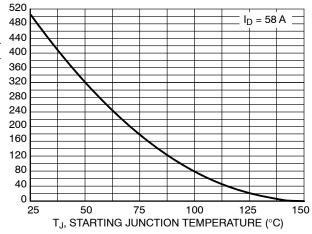


Figure 12. Maximum Avalanche Energy vs.
Starting Junction Temperature

TYPICAL CHARACTERISTICS

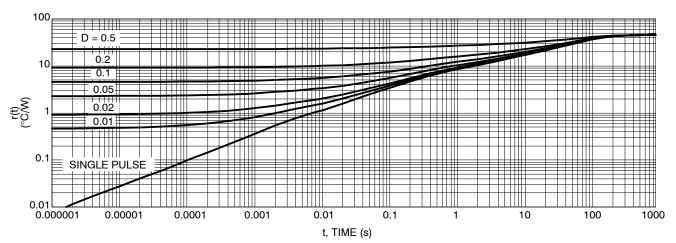
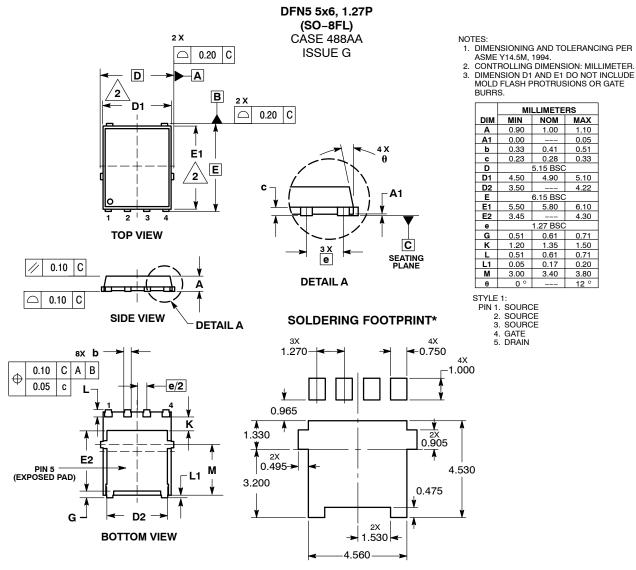


Figure 13. Thermal Response



Figure 14. GFS vs. I_D

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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